

Product Summary

$V_{(BR)DSS}$	$R_{DS(ON)}$ Max	I_D Max $T_A = +25^\circ\text{C}$
-12V	16m Ω @ $V_{GS} = -4.5\text{V}$	-9.1A
	21.5m Ω @ $V_{GS} = -2.5\text{V}$	-7.9A
	26m Ω @ $V_{GS} = -1.8\text{V}$	-7.0A
	32m Ω @ $V_{GS} = -1.5\text{V}$	-6.3A

Description

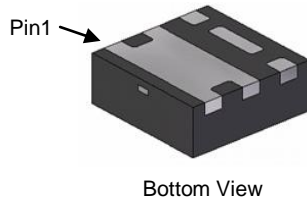
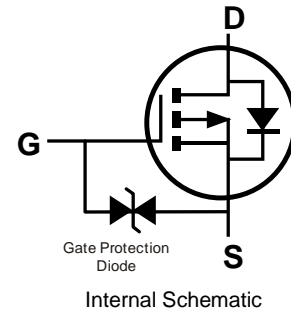
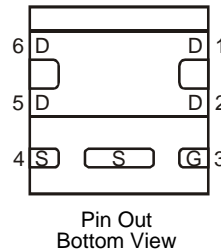
This MOSFET is designed specifically for use in battery management applications.

Features

- 0.6mm Profile – Ideal For Low Profile Applications
- PCB Footprint of 4mm²
- Low Gate Threshold Voltage
- Fast Switching Speed
- ESD Protected to 3KV
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: U-DFN2020-6
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish – NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 **(e4)**
- Weight: 0.0065 grams (Approximate)

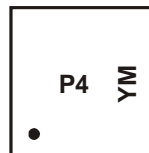

U-DFN2020-6


Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Quantity per reel
DMP1022UFDE-7	P4	7	3,000

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



P4 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: Y = 2011)
 M = Month (ex: 9 = September)

Date Code Key

Year	2011	~	2015	2016	2017	2018	2019	2020	2021	2022	2023	
Code	Y	~	C	D	E	F	G	H	I	J	K	
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	-12	V
Gate-Source Voltage			V _{GSS}	±8	V
Continuous Drain Current (Note 6) V _{GS} = -4.5V	Steady State	T _A = +25°C T _A = +70°C	I _D	-9.1 -7.2	A
	t < 5s	T _A = +25°C T _A = +70°C	I _D	-11.2 -9.0	A
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			I _{DM}	-90	A
Continuous Source-Drain Diode Current		T _A = +25°C T _C = +25°C	I _S	-2.5 -7.1	A
Pulsed Source-Drain Diode Current (10µs pulse, duty cycle = 1%)			I _{SM}	-50	A

Thermal Characteristics

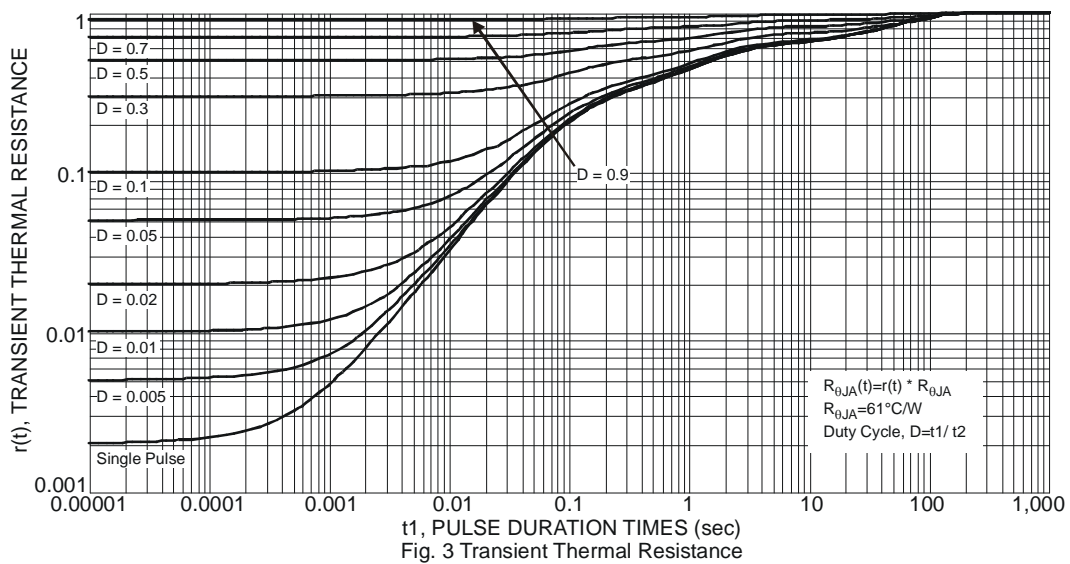
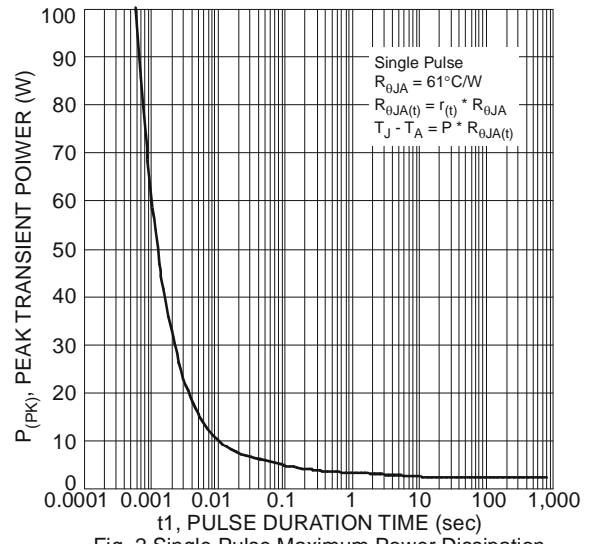
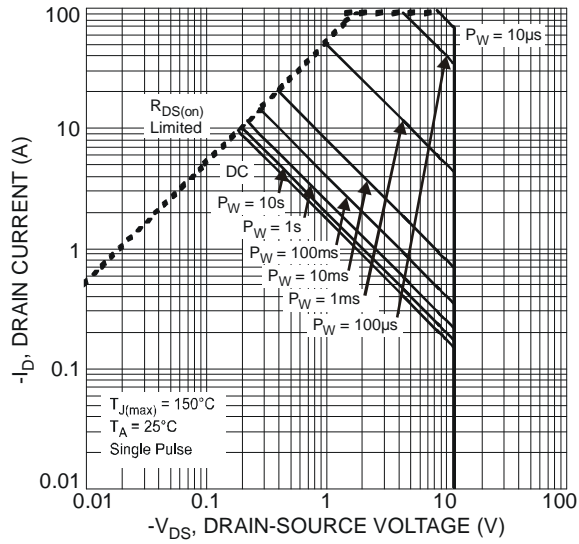
Characteristic		Symbol	Value	Units
Total Power Dissipation (Note 5)	T _A = +25°C	P _D	0.66	W
	T _A = +70°C		0.42	
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	R _{θJA}	189	°C/W
	t < 5s		123	
Total Power Dissipation (Note 6)	T _A = +25°C	P _D	2.03	W
	T _A = +70°C		1.3	
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	R _{θJA}	61	°C/W
	t < 5s		40	
Thermal Resistance, Junction to Case (Note 6)	Steady state	R _{θJC}	9.3	
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

- Notes:
5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1-inch square copper plate

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	-12	—	—	V	V _{GS} = 0V, I _D = -250μA
Zero Gate Voltage Drain Current (T _J = +25°C)	I _{DSS}	—	—	-200	nA	V _{DS} = -12V, V _{GS} = 0V
Zero Gate Voltage Drain Current (T _J = +55°C) (Note 8)	I _{DSS}	—	—	-2	μA	V _{DS} = -12V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	—	—	±2	μA	V _{GS} = ±5V, V _{DS} = 0V
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	-0.35	—	-0.8	V	V _{DS} = V _{GS} , I _D = -250μA
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)} /ΔT _J	—	2.5	—	mV/°C	I _D = -250μA
On-State Drain Current	I _{D(ON)}	-10	—	—	A	V _{GS} = -4.5V, V _{DS} < -5A
Static Drain-Source On-Resistance	R _{DS(ON)}	—	12	16	mΩ	V _{GS} = -4.5V, I _D = -8.2A
			15	21.5		V _{GS} = -2.5V, I _D = -7.2A
			20	26		V _{GS} = -1.8V, I _D = -6.6A
			23	32		V _{GS} = -1.5V, I _D = -1A
			80	160		V _{GS} = -1.2V, I _D = -1A
Forward Transfer Admittance	Y _{fs}	—	12	—	S	V _{DS} = -4V, I _D = -8.2A
Diode Forward Voltage	V _{SD}	—	-0.8	-1.2	V	V _{GS} = 0V, I _S = -8A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	—	2,953	—	pF	V _{DS} = -4V, V _{GS} = 0V, f = 1.0MHz
Output Capacitance	C _{oss}	—	756	—		
Reverse Transfer Capacitance	C _{rss}	—	678	—		
Gate Resistance	R _g	—	8.6	18	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1MHz
Total Gate Charge	Q _g	—	28.4	42.6	nC	V _{GS} = -5V, V _{DS} = -4, I _D = -10A
Total Gate Charge	Q _g	—	25.3	38		
Gate-Source Charge	Q _{gs}	—	2.3	—		
Gate-Drain Charge	Q _{gd}	—	7.2	—		
Turn-On Delay Time	t _{D(on)}	—	20	30	nS	V _{DS} = -4V, V _{GS} = -4.5V, R _G = 1Ω, R _L = 0.4Ω, I _D = -9.8A
Turn-On Rise Time	t _r	—	28	42		
Turn-Off Delay Time	t _{D(off)}	—	117	176		
Turn-Off Fall Time	t _f	—	93	139		
BODY DIODE CHARACTERISTICS						
Diode Forward Voltage	V _{SD}	—	-0.8	-1.2	V	V _{GS} = 0V, I _S = -9.8A
Continuous Source-Drain Diode Current (Note 6)	I _S	—	—	-2.5	A	T _A = +25°C
		—	—	-7.1		T _C = +25°C
Pulse Diode Forward Current (Note 8)	I _{SM}	—	—	-50	—	—
Body Diode Reverse Recovery Time (Note 8)	t _{rr}	—	28	56	nS	I _S = -9.8A, di/dt = 100A/μs
Reverse Recovery Fall Time	t _a	—	10	—		
Reverse Recovery Rise Time	t _b	—	18	—		
Body Diode Reverse Recovery Charge (Note 8)	Q _{rr}	—	13	26		

Notes: 7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to production testing.



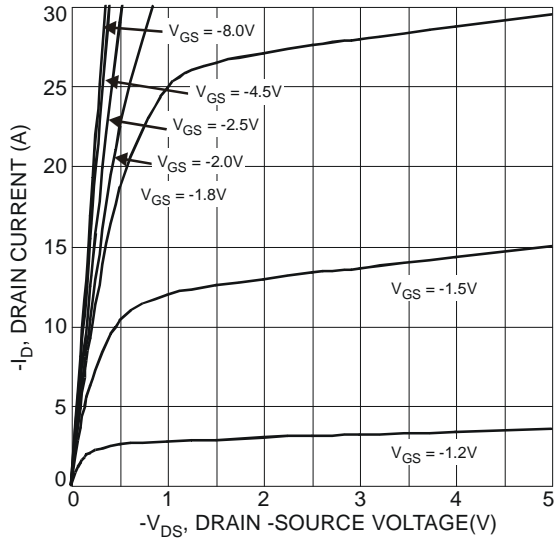


Fig. 4 Typical Output Characteristics

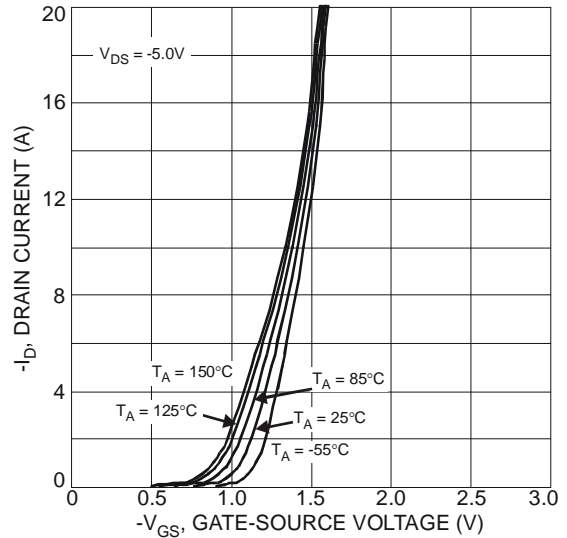


Fig. 5 Typical Transfer Characteristics

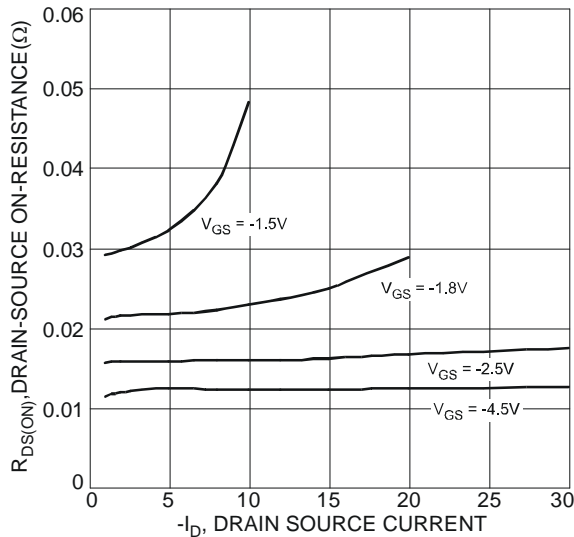


Fig. 6 Typical On-Resistance vs. Drain Current and Gate Voltage

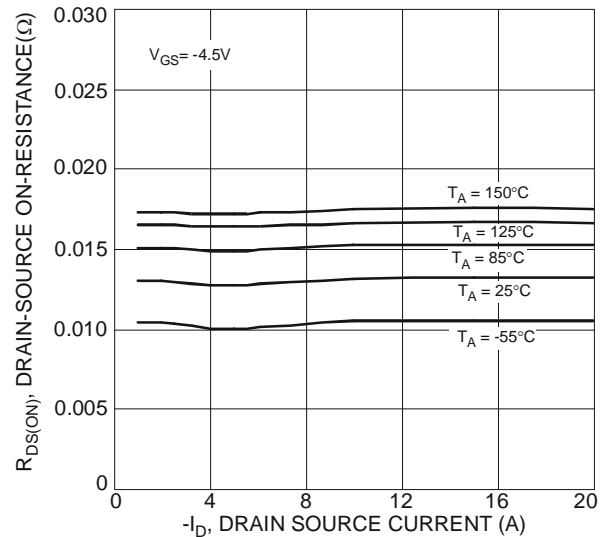


Fig. 7 Typical On-Resistance vs. Drain Current and Temperature

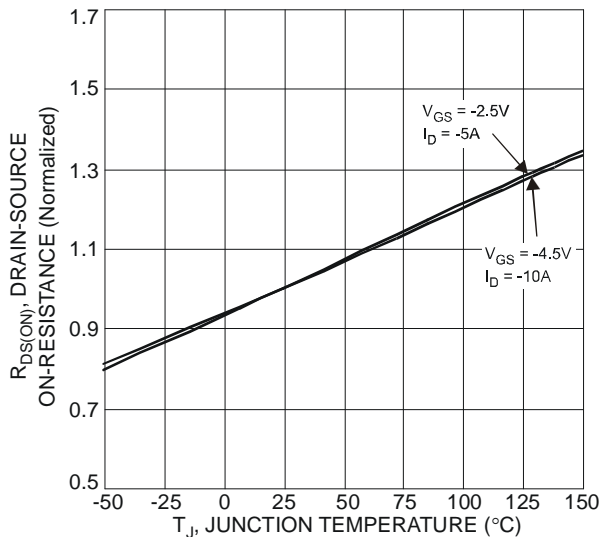


Fig. 8 On-Resistance Variation with Temperature

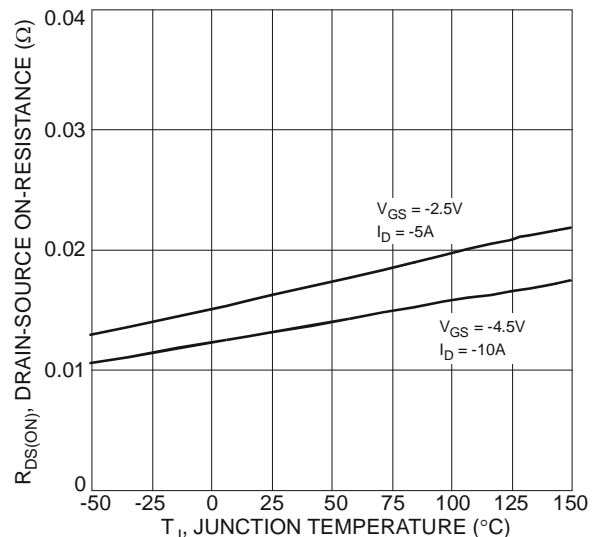


Fig. 9 On-Resistance Variation with Temperature

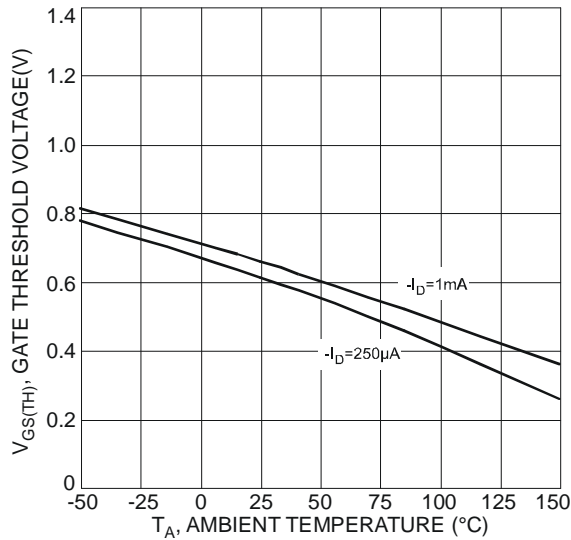


Fig. 10 Gate Threshold Variation vs. Ambient Temperature

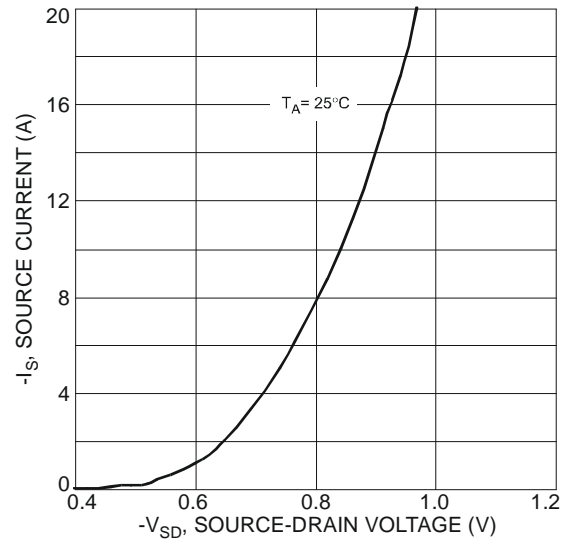


Fig. 11 Diode Forward Voltage vs. Current

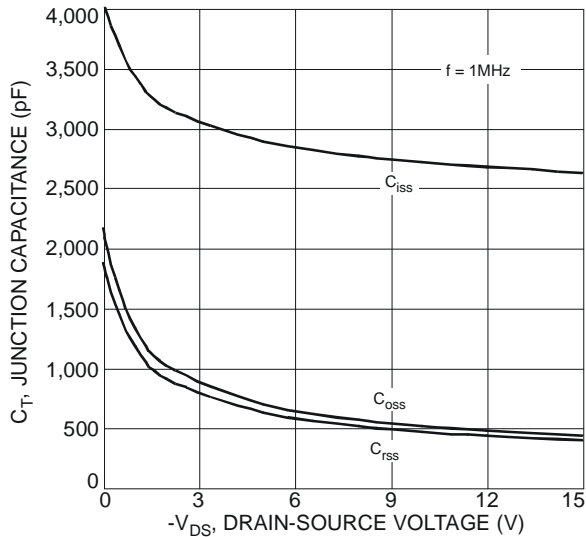


Fig. 12 Typical Junction Capacitance

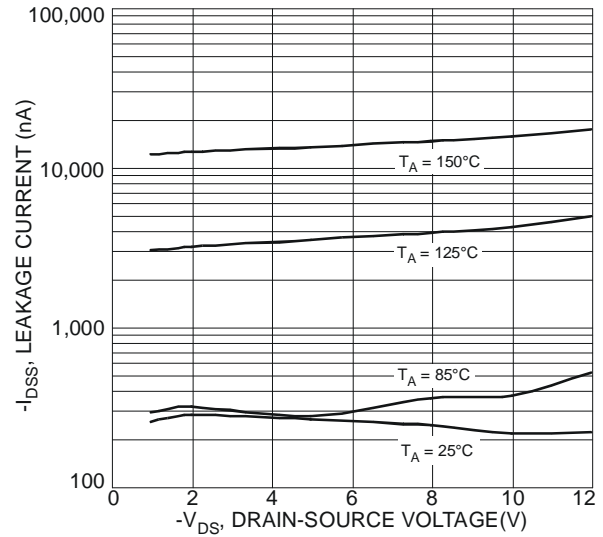


Fig. 13 Typical Drain-Source Leakage Current vs. Voltage

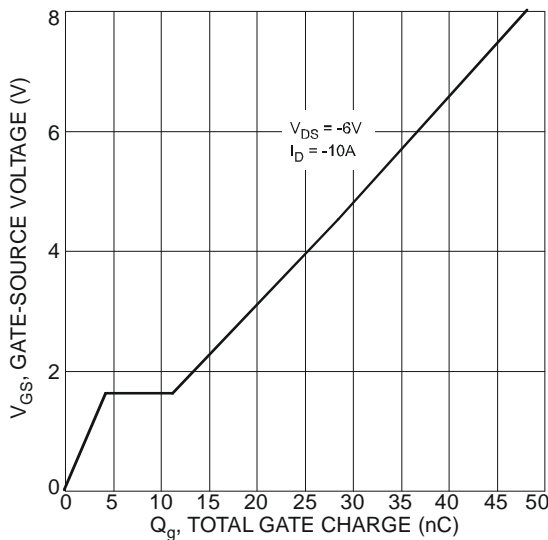
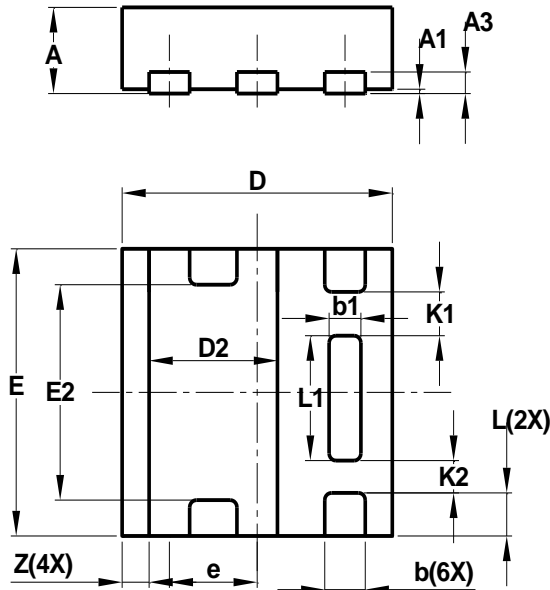


Fig. 14 Gate-Charge Characteristics

Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.

**U-DFN2020-6
(Type E)**

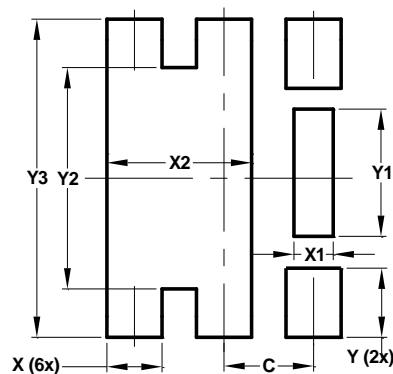


U-DFN2020-6 (Type E)			
Dim	Min	Max	Typ
A	0.57	0.63	0.60
A1	0	0.05	0.03
A3	-	-	0.15
b	0.25	0.35	0.30
b1	0.185	0.285	0.235
D	1.95	2.05	2.00
D2	0.85	1.05	0.95
E	1.95	2.05	2.00
E2	1.40	1.60	1.50
e	-	-	0.65
L	0.25	0.35	0.30
L1	0.82	0.92	0.87
K1	-	-	0.305
K2	-	-	0.225
Z	-	-	0.20
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.

**U-DFN2020-6
(Type E)**



Dimensions	Value (in mm)
C	0.650
X	0.400
X1	0.285
X2	1.050
Y	0.500
Y1	0.920
Y2	1.600
Y3	2.300

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